Get full scholarship! **HOSEI Short-term** Scholarship Program for High School Students (HOSEI-SSP)

January 18th to January 22nd 2017

We invite you to join HOSEI Short-term Scholarship Program for High School Students (HOSEI-SSP), an exciting and unique study abroad experience at HOSEI University, an international university in Tokyo, Japan. High school students from 7 countries in Asia (Cambodia, Indonesia, Laos, Malaysia, Myanmar, Thailand and Vietnam) who graduate from and enter college in 2017, 2018 or 2019 are welcome to apply.











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PROGRAM DETAILS

■ Program Duration

Wednesday, January 18 – Sunday, January 22, 2017 (5 days)

Eligibility

Applicants must meet all of the following items:

- 1. Your nationality must be other than Japanese, or dual nationality of Japanese and another.
- 2. You must be enrolled in the high school in 7 countries in Asia (Cambodia, Indonesia, Laos, Malaysia, Myanmar, Thailand and Vietnam) and graduate from and enter college in 2017, 2018 or 2019.
- 3. You must have a level of English proficiency equivalent to one of the following:

☐TOEFL iBT® Test: 76 or above

☐TOEIC ® Test: 820 or above

□IELTS (Academic Module) band: 6.0 or above

Number of students to be accepted

10 students

Program Fee

Complete financial support including airfare to and from Japan, accommodation, meal expenses, domestic travelling costs. Transportation in your country and personal spending money are not included.

■ Itinerary (tentative)

Date	Activities
January 18	Arrival and check in the hotel
January 19	AM: Orientation and Japanese language class
	PM: Special lecture on Japanese Tourism Development
January 20	AM: Special lecture on Population Trend and Business in Japan
	PM: Special lecture on Introduction to Japanese Society and Sustainability
January 21	AM: Experience of Japanese traditional culture
	PM: Tokyo sightseeing and Farewell party
January 22	Check out the hotel and Departure

HOW TO APPLY

Application Documents and Process

Submission of application documents by e-mail after online registration. For details, please check the website. http://www.hosei.ac.jp/english/news_information/archive_2016/160824.html

*Application Deadline: Wednesday, October 5, 2016. (We must receive your application through e-mail by this date.)



Location

"ICHIGAYA Campus", HOSEI University. The campus is located in the midway between the lidabashi and Ichigaya stations. It takes 10 minutes by train from Shinjuku to the stations.